Application Data Sheet

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Application Information Application number:: Filing Date:: Application Type:: Regular Subject Matter:: Utility Suggested classification:: Suggested Group Art Unit:: CD-ROM or CD-R??:: Number of CD disks:: Number of copies of CDs:: Sequence Submission:: Computer Readable Form (CRF)?:: Number of copies of CRF:: Title:: METHOD AND STRUCTURE FOR FABRICATING A HALFTONE MASK FOR THE MANUFACTURE OF SEMICONDUCTOR WAFERS 021653-002200US Attorney Docket Number:: Request for Early Publication:: No Request for Non-Publication:: No Suggested Drawing Figure:: **Total Drawing Sheets::** 3 Small Entity?:: No Latin name:: Variety denomination name:: Petition included?:: No Petition Type::

Contract or Grant Numbers One::

Secrecy Order in Parent Appl.::

No

Applicant Information

Applicant Authority Type::

Inventor

Primary Citizenship Country::

Peoples Republic of China

Status::

Full Capacity

Given Name::

Cong

Middle Name::

Family Name::

Lu

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State or Province of Residence::

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City of Mailing Address::

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State or Province of mailing address::

Country of mailing address::

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Postal or Zip Code of mailing address:: 201203

Correspondence Information

Correspondence Customer Number::

20350

Representative Information

Representative Customer Number::

20350

Domestic Priority Information

Application::

Continuity Type::

Parent Application:: Parent Filing Date::

Foreign Priority Information

Country::

Application number::

Filing Date::

People's Republic of China

200310122965.x .

12/30/03

Assignee Information

Assignee Name::

Semiconductor Manufacturing International (Shanghai) Corporation

Street of mailing address:: 18 Zhang Jiang Road, Pudong New Area

City of mailing address::

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Initial 2/3/04